

SOIPIX
Silicon-On-Insulator Pixel Detector Project



Imaging Devices Laboratory



Performance Improvement of the Event-Driven SOI Pixel Detectors for X-ray Astronomy

21st International Workshop on Radiation Imaging
@ Orthodox Academy of Crete (OAC), Chania, Crete, Greece
7 – 12 July 2019

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Outline

- **Introduction for X-ray Astronomy**
- **XRPIX Series**
- **Improvement of energy resolution for event-driven mode**
 - > **XRPIX6D / XRPIX6E**
- **Summary**

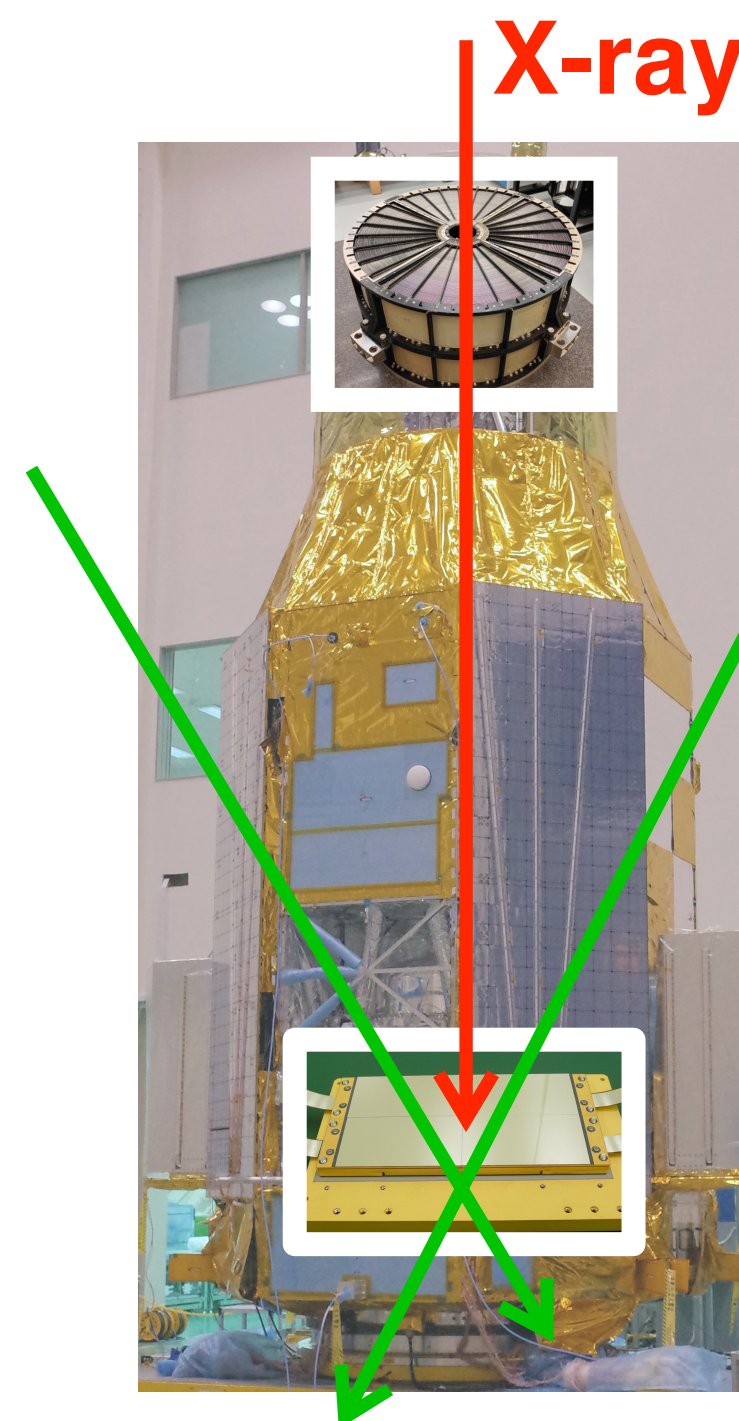
Detector for X-ray Astronomy

Standard imaging spectrometer of modern X-ray astronomical satellites ...

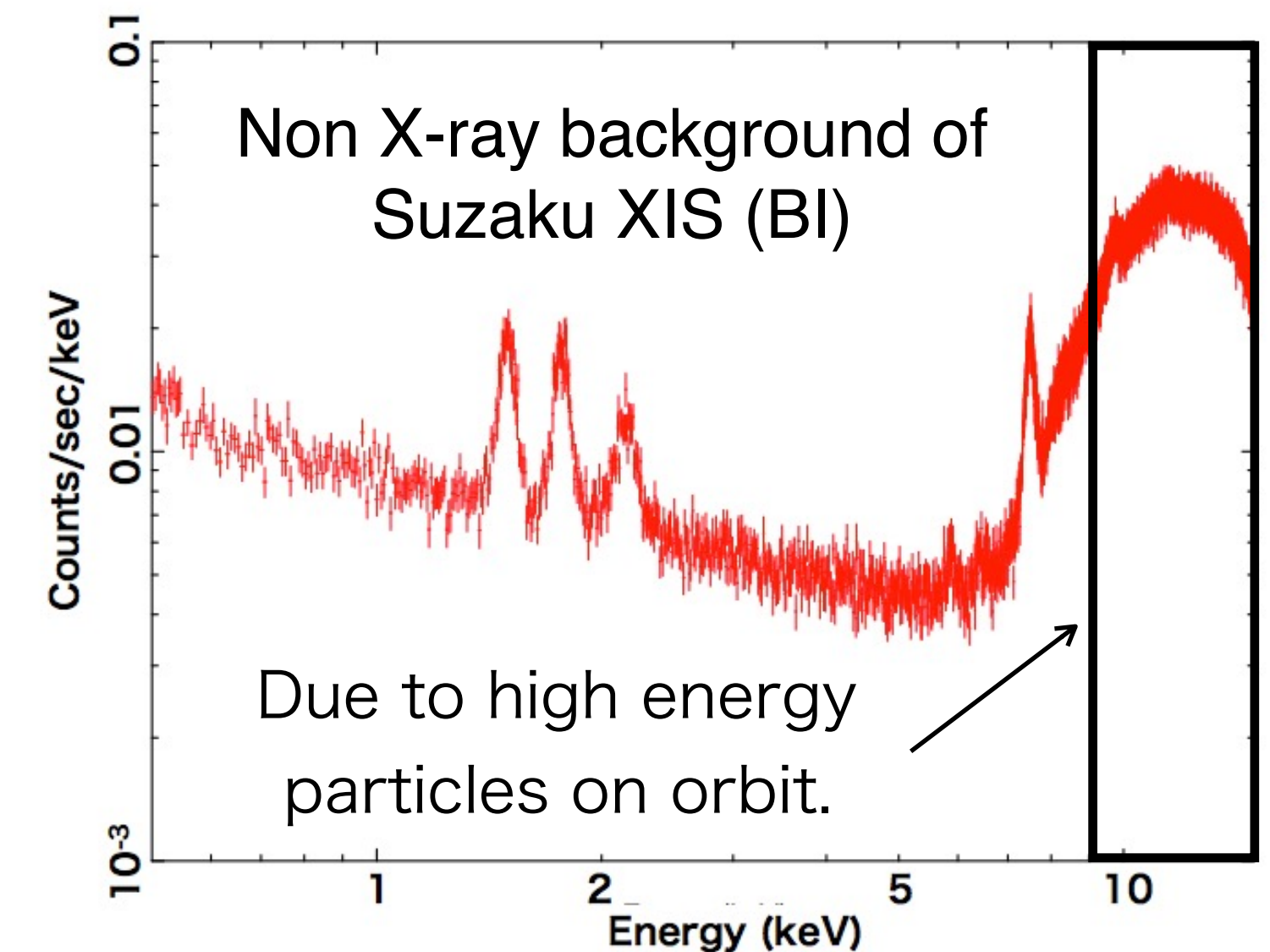
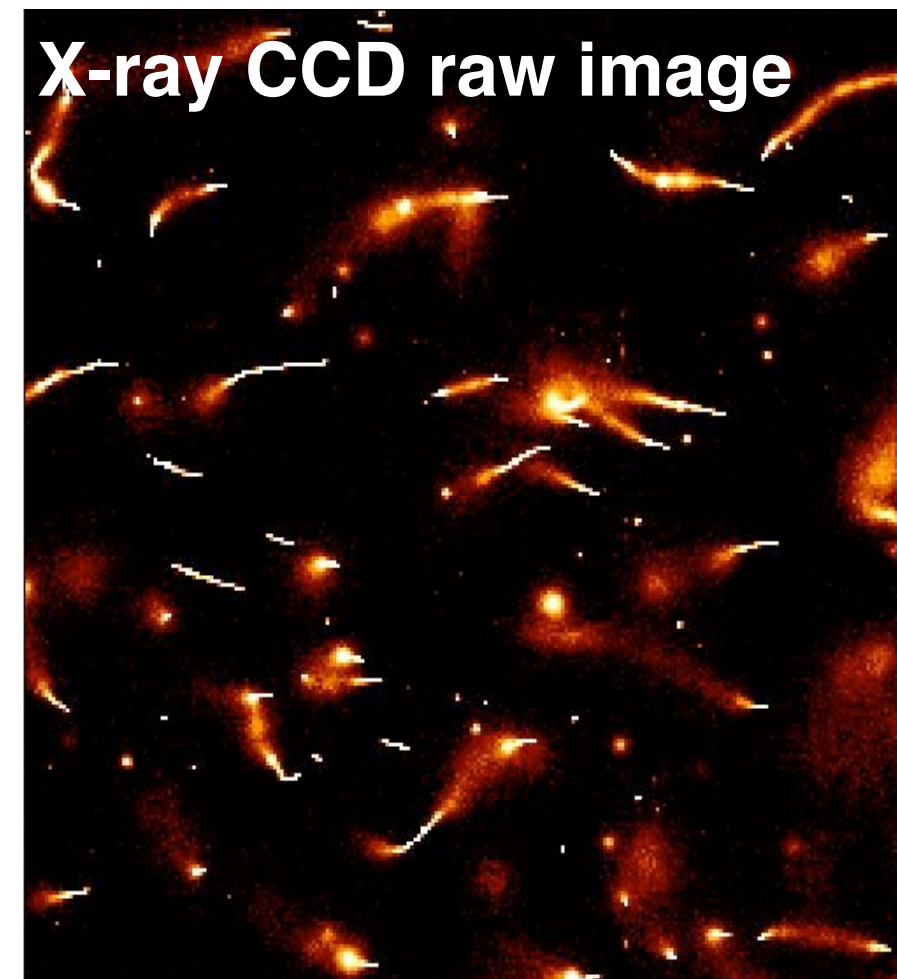
- > **X-ray CCD** : Wide and fine imaging with the sensor size of $\sim 20 - 30$ mm, pixel size of $\sim 30 \mu\text{m}$ sq.
Fano limited spectroscopy with the readout noise $\sim 3 e^-$ (rms).

However ...

- > **Non X-ray background** (NXB) above 10 keV is too high to study faint sources.
- > **The timing resolution** is too poor ($\sim \text{sec}$) to make fast timing observation of time variable source.



high energy particle



XRPIX for Future X-ray Astronomy

The performance required of a future X-ray astronomical satellite is the following ...

Target Specification

- (1) FWHM ≤ 140 eV at 6 keV
Readout Noise : req. ≤ 10 e⁻ / goal ≤ 3 e⁻
- (2) < 100 μm pitch pixel
- (3) ~ 10 μs per event readout (Trigger, Direct Pixel Access)
- (4) Wide energy range : 0.3– 40 keV (Thick Depletion Stacks)

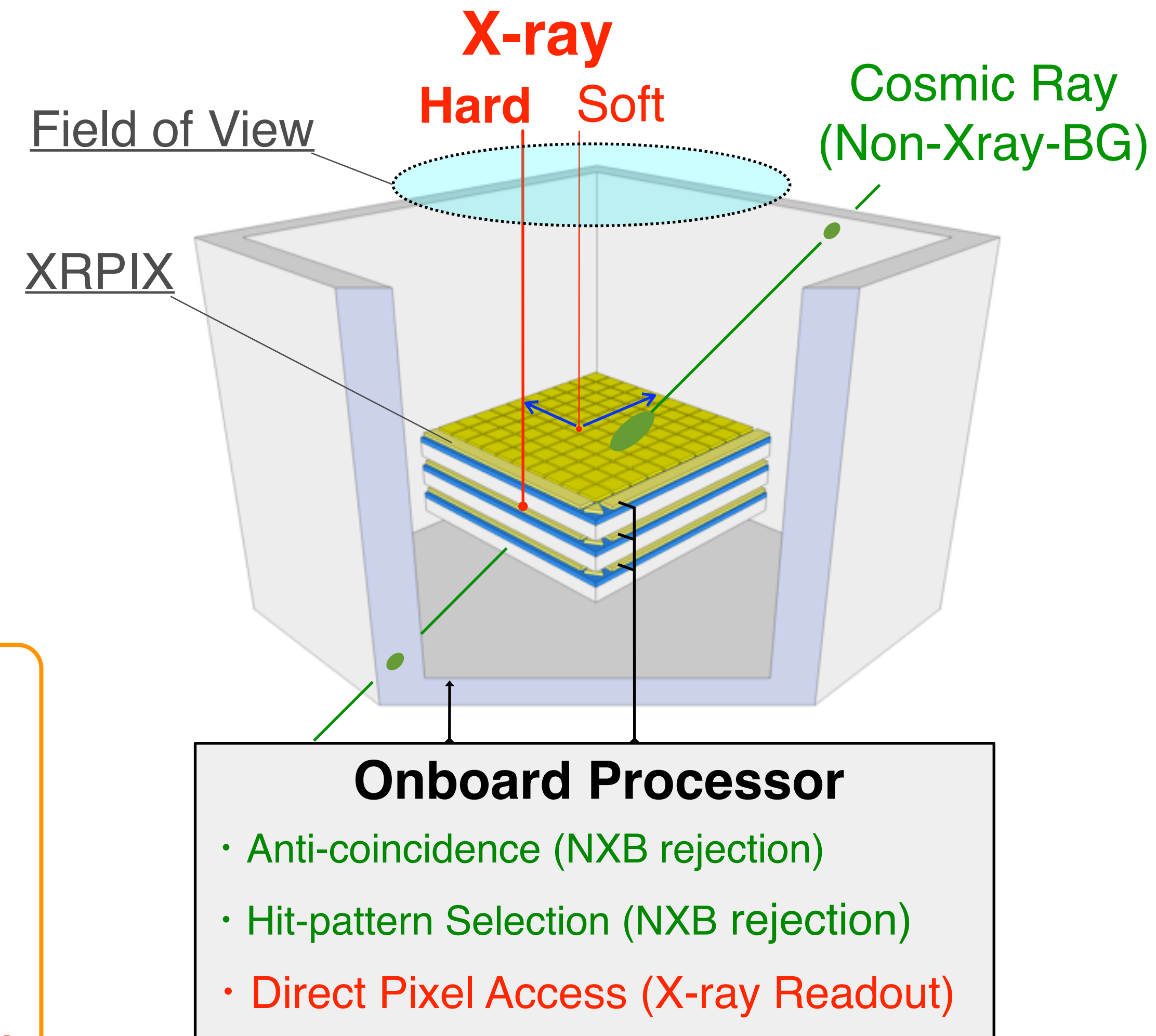
In order to achieve specification, we have been developing X-ray SOI Pixel Detector (XRPIX).

XRPIX has self-trigger function !

-> Realization of event-driven

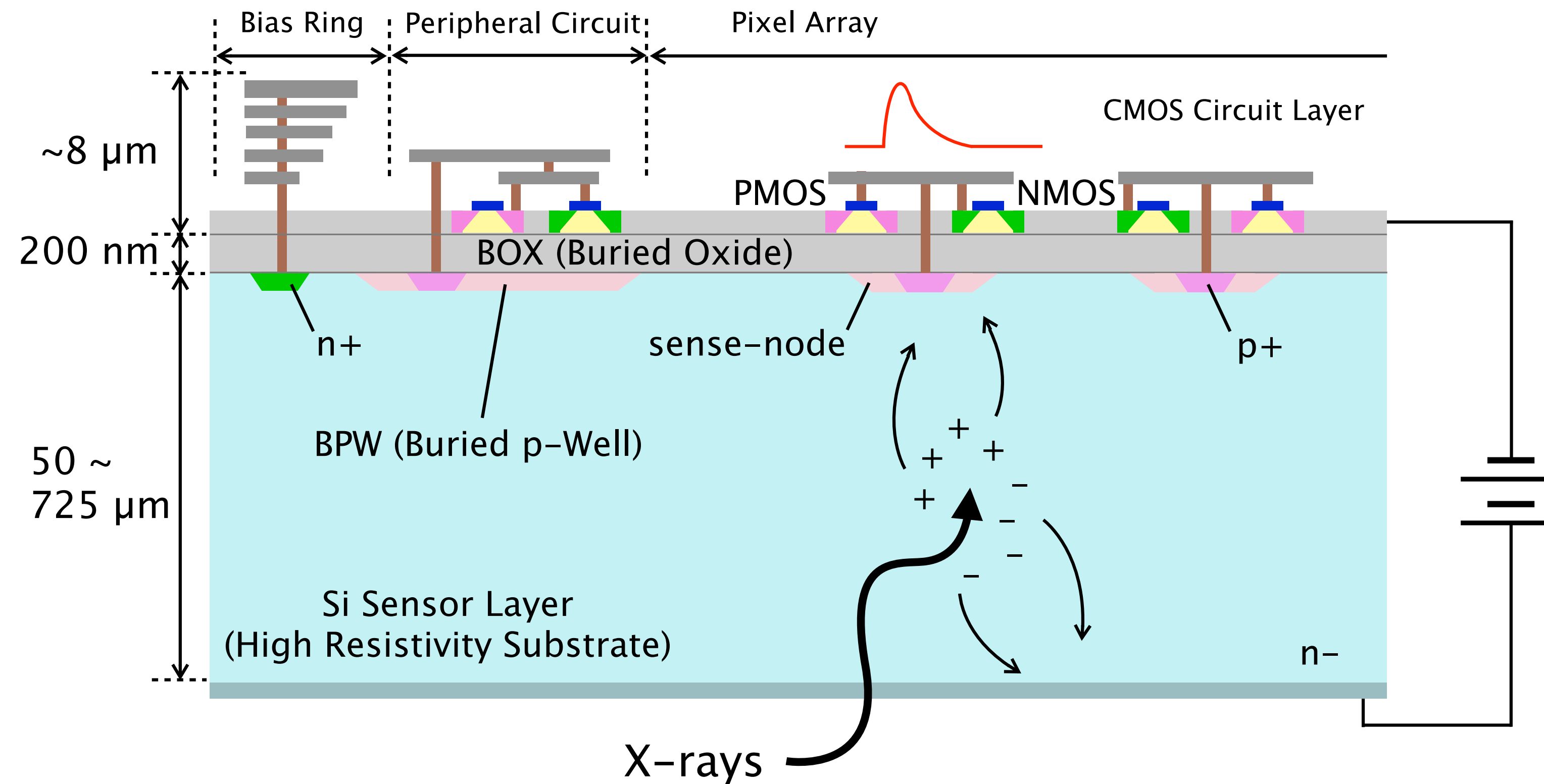
-> Improve observation efficiency by reducing high-energy electrons generated by charged particles and gamma rays.

X-ray SOIPIX with Active Shield



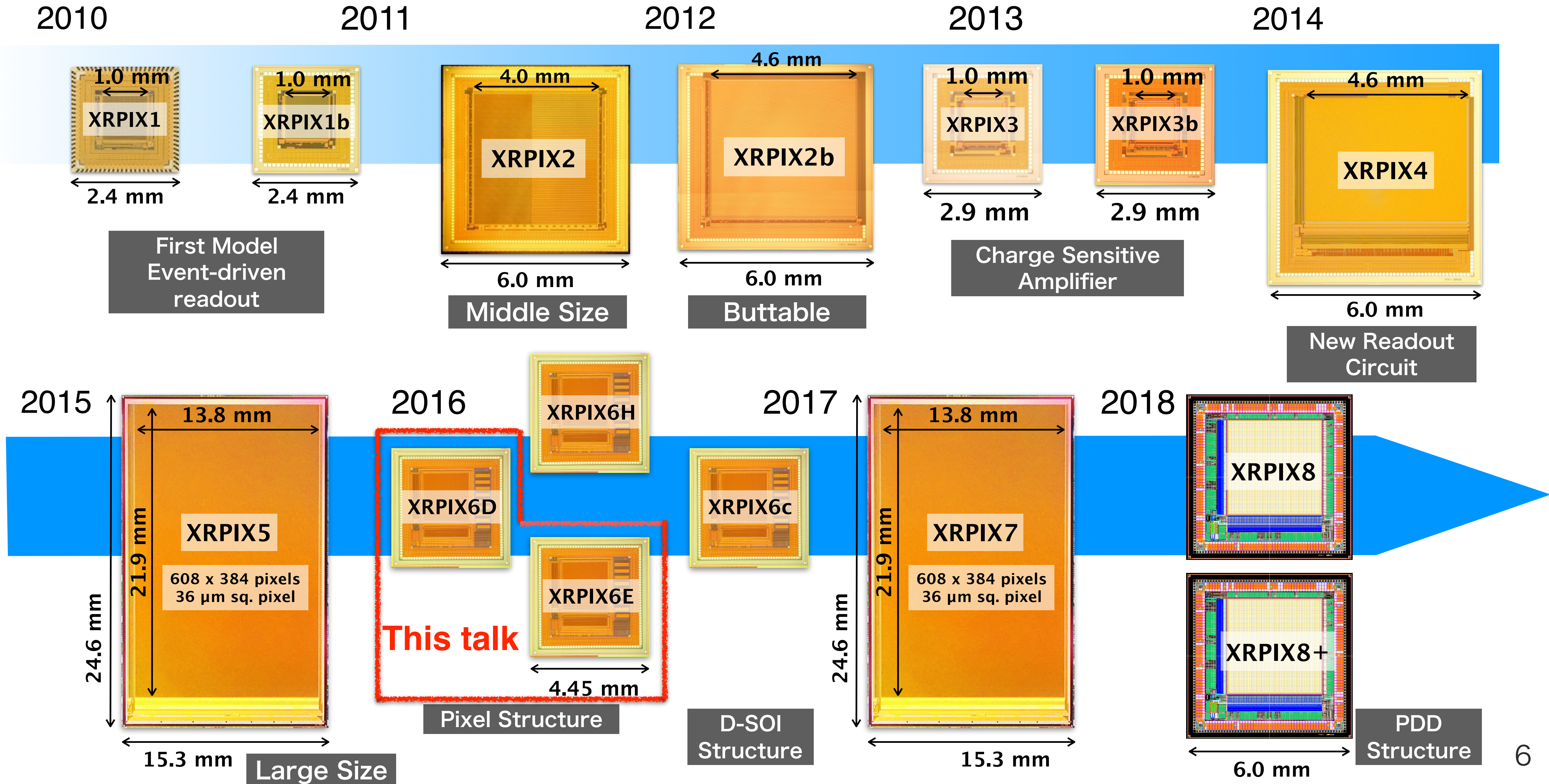
SOI Pixel Detector

- A monolithic pixel detector with silicon-on-insulator (SOI) CMOS Technology
 - > 0.2 μm fully-depleted (FD) - SOI pixel process
- SOI Pixel Detector (SOIPIX) : Processed by LAPIS Semi. Co., Ltd.



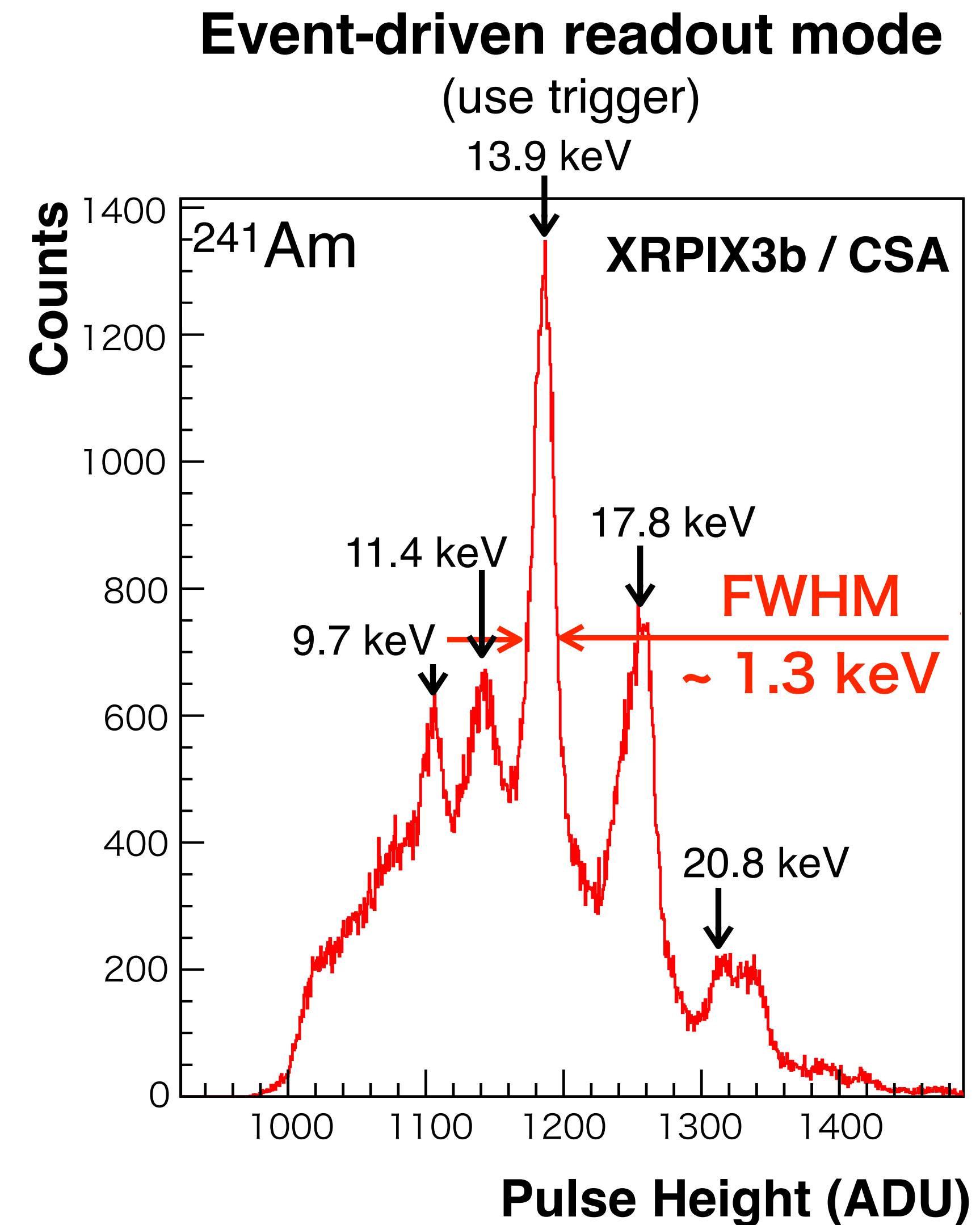
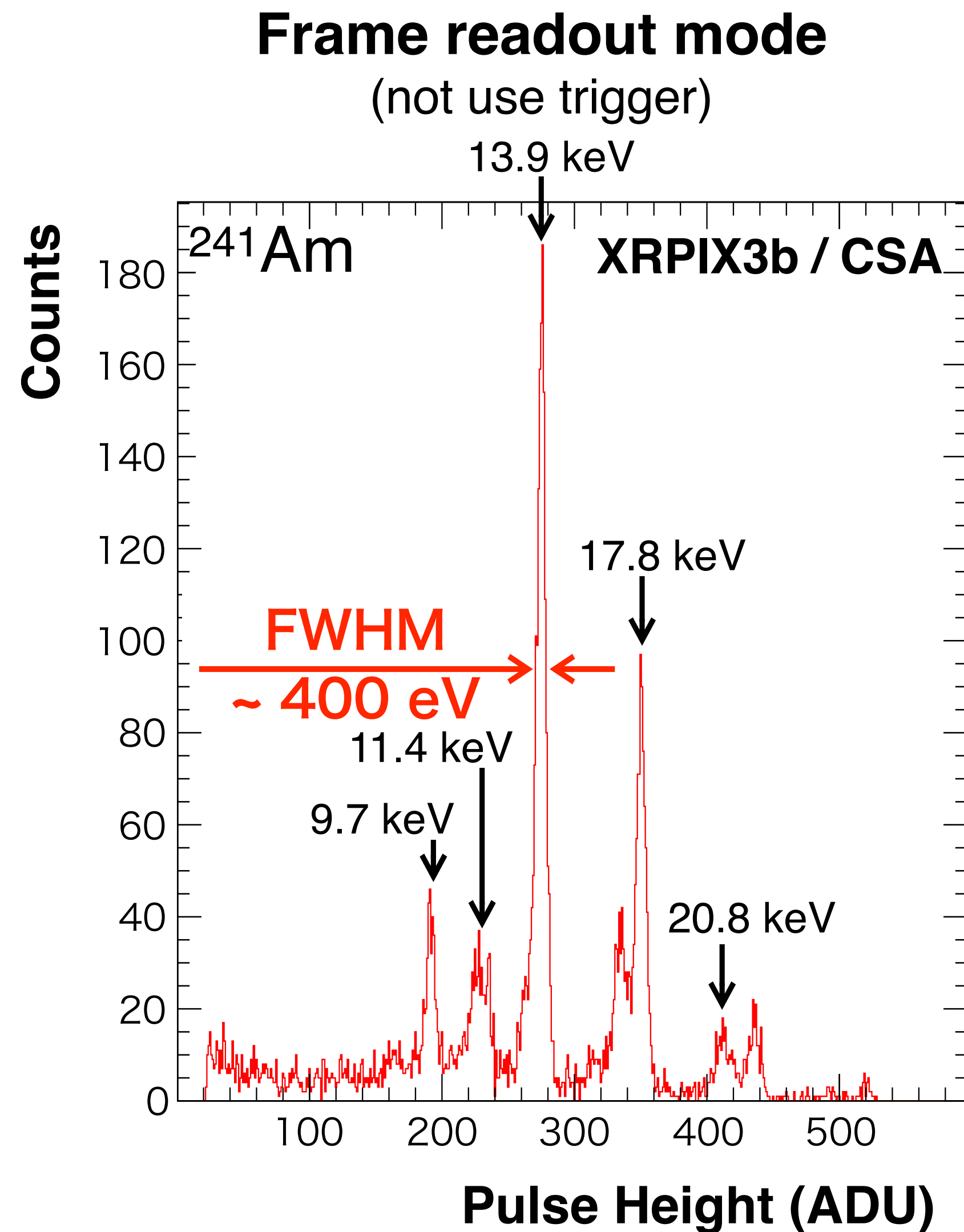
Both high X-ray sensitivity and advanced signal processing are compatible!

History of XRPIX Series

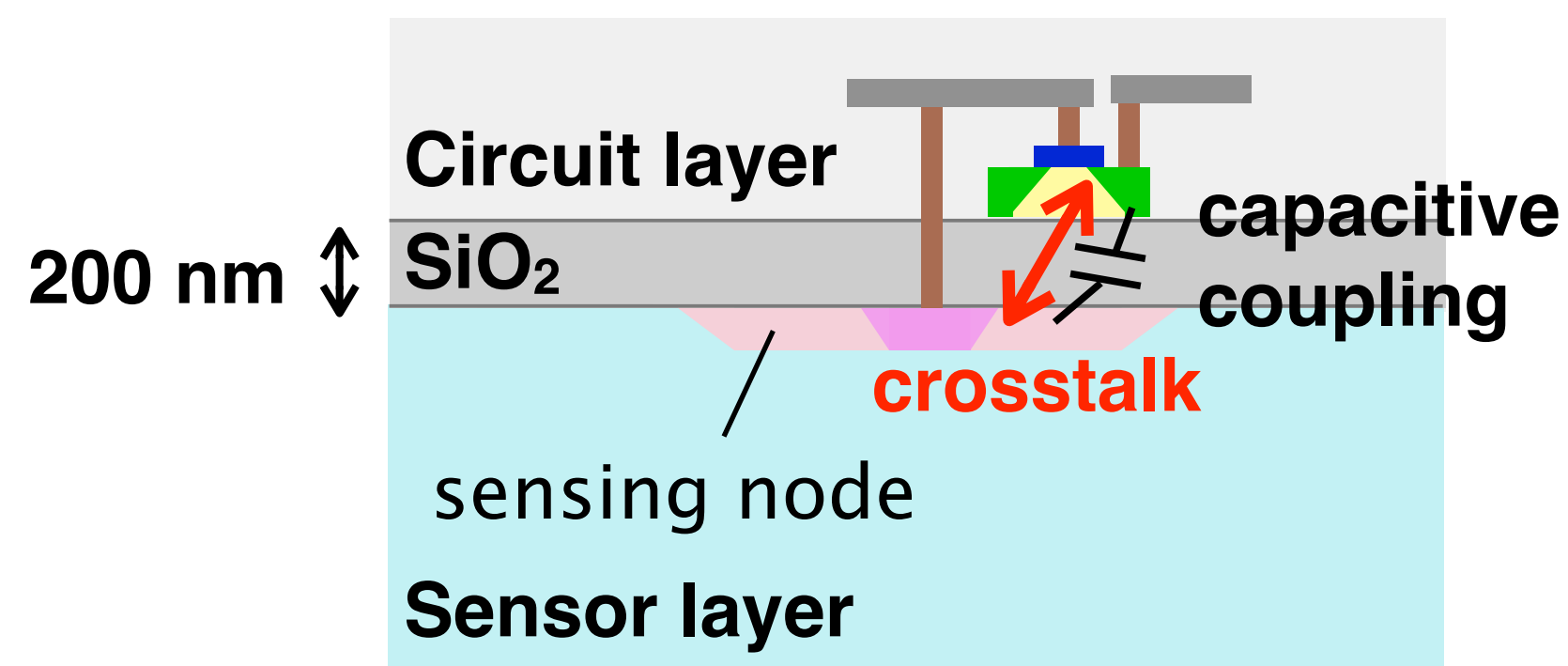


Signal Deterioration by Event-driven mode

We had a critical issue in event-driven mode... The signal is degraded...

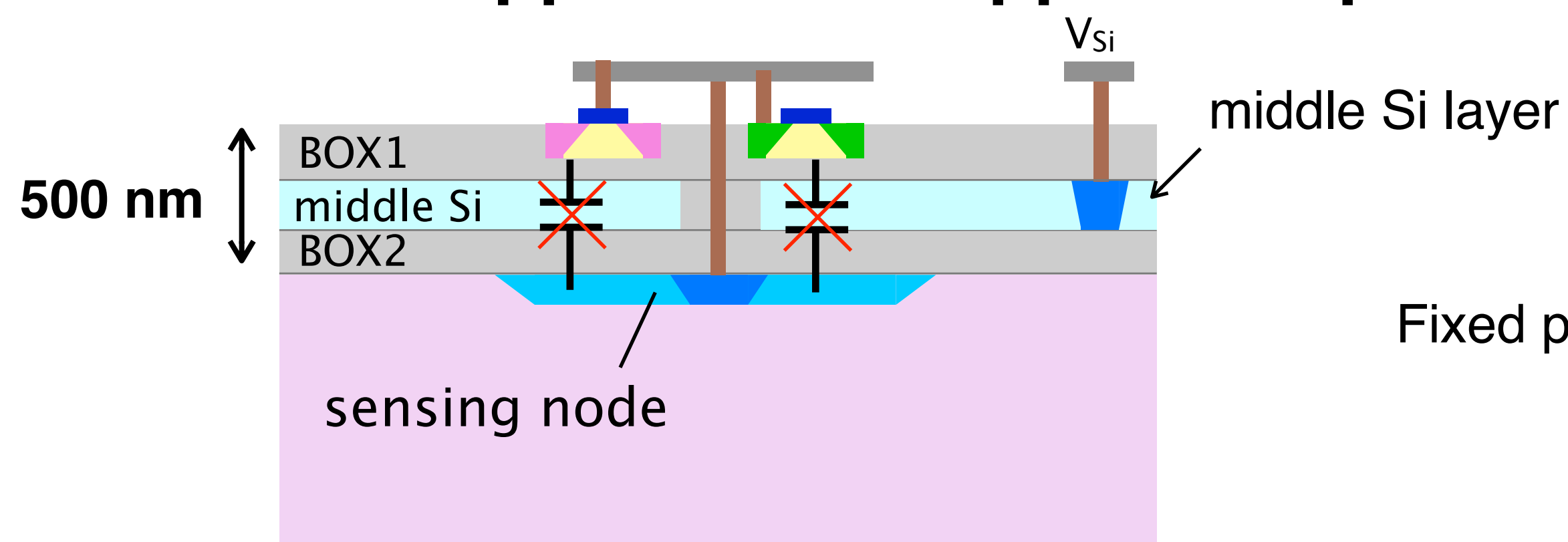


Improvement for interference issue

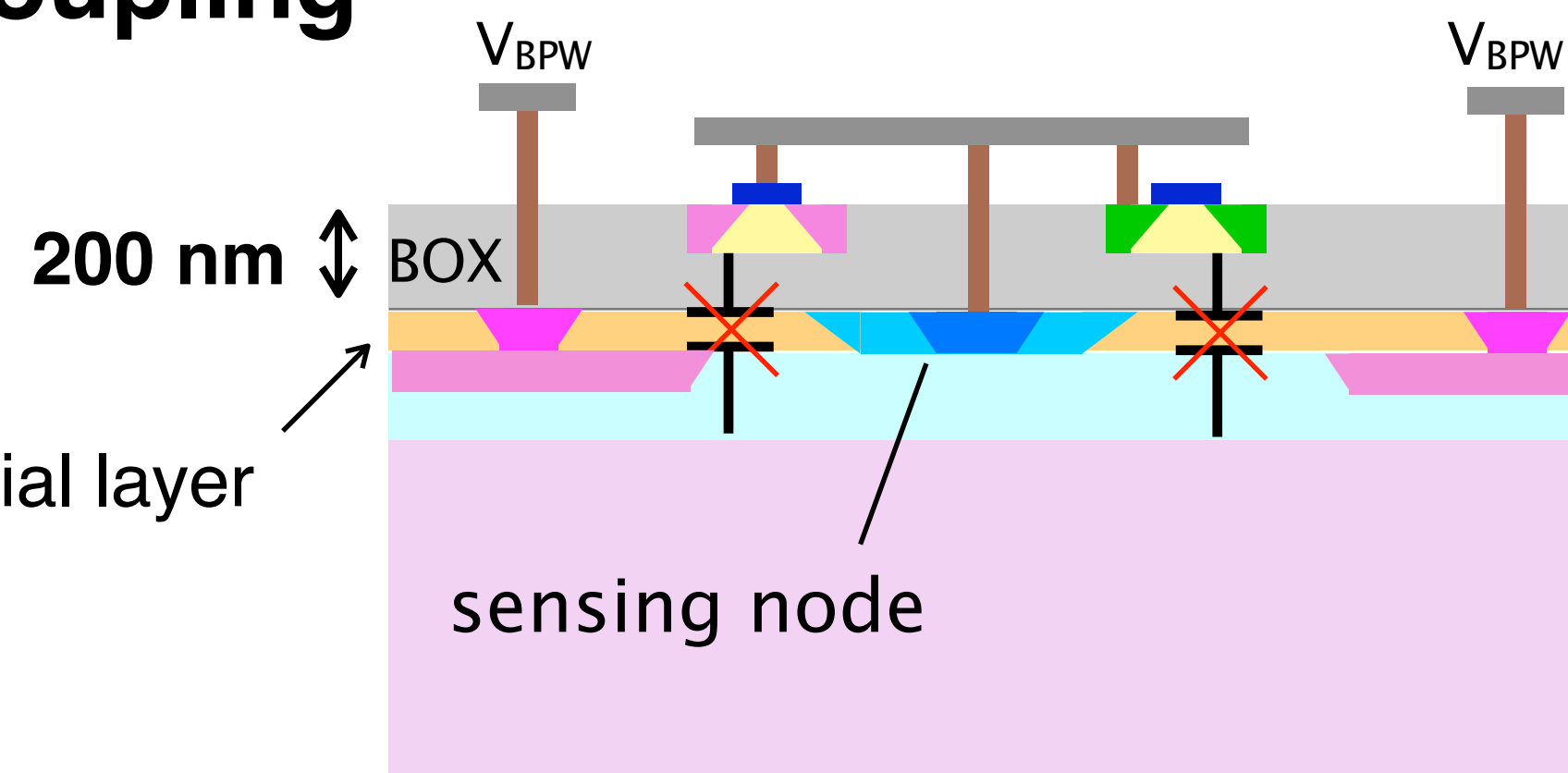


- We understood that the signal degradation was caused by interference of digital signal in the pixel.
 - The digital signal transmits a signal change of the comparator inversion to the analog signal via the parasitic capacitance.
 - > It is important to suppress capacitive coupling
- * Takeda+2014, Ohmura+2016

new approach to suppress capacitive coupling



Double SOI (D-SOI) structure
-> XRPIX6D



Pinned Depleted Diode (PDD) structure
-> XRPIX6E

XRPIX6 Design Specification

We aim to improve spectroscopic performance by developing advanced sensor structure.

XRPIX6H -> Conventional Single-SOI

XRPIX6D -> Double-SOI

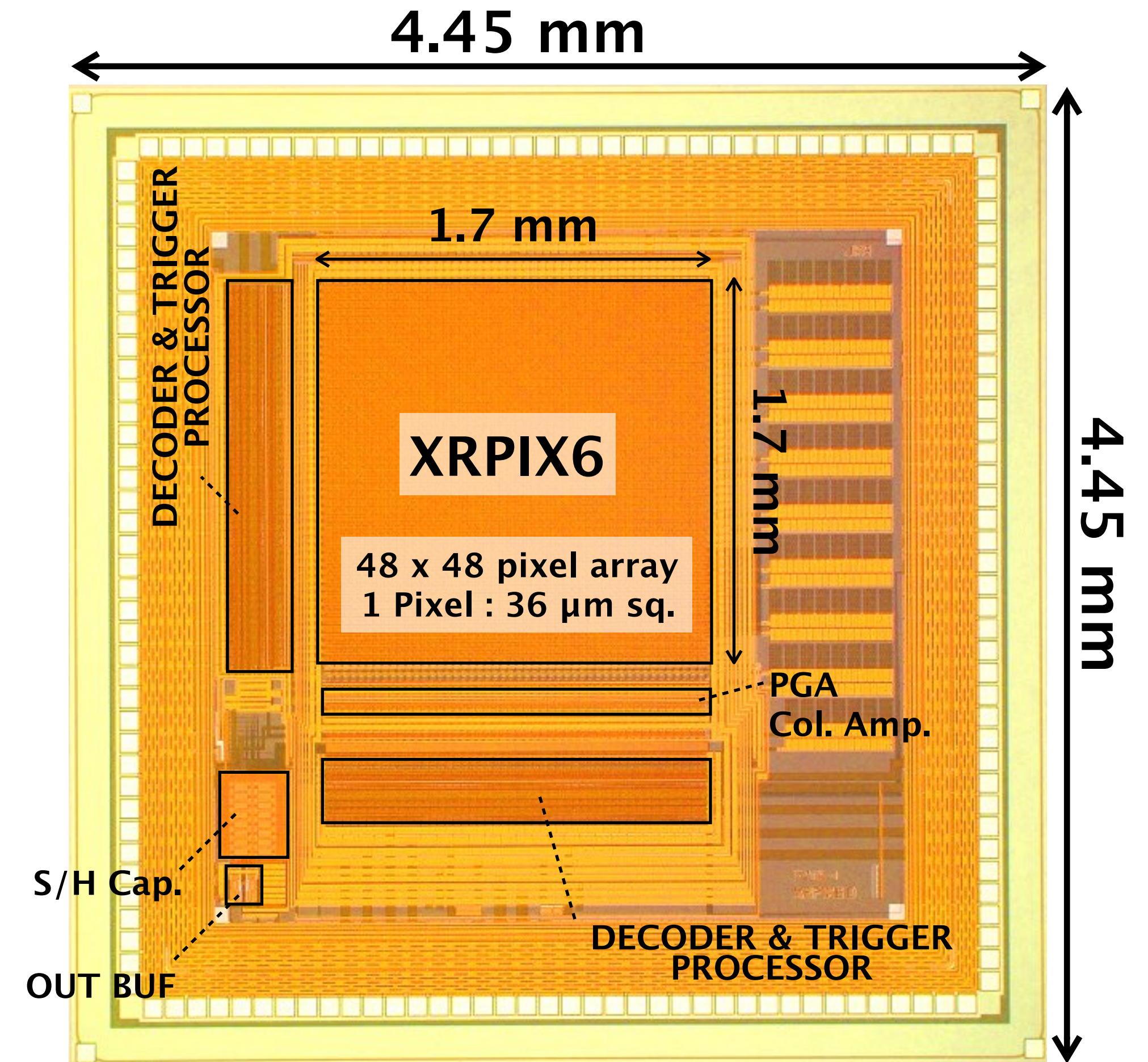
XRPIX6E -> Pinned Depleted Diode (Single-SOI)

Components

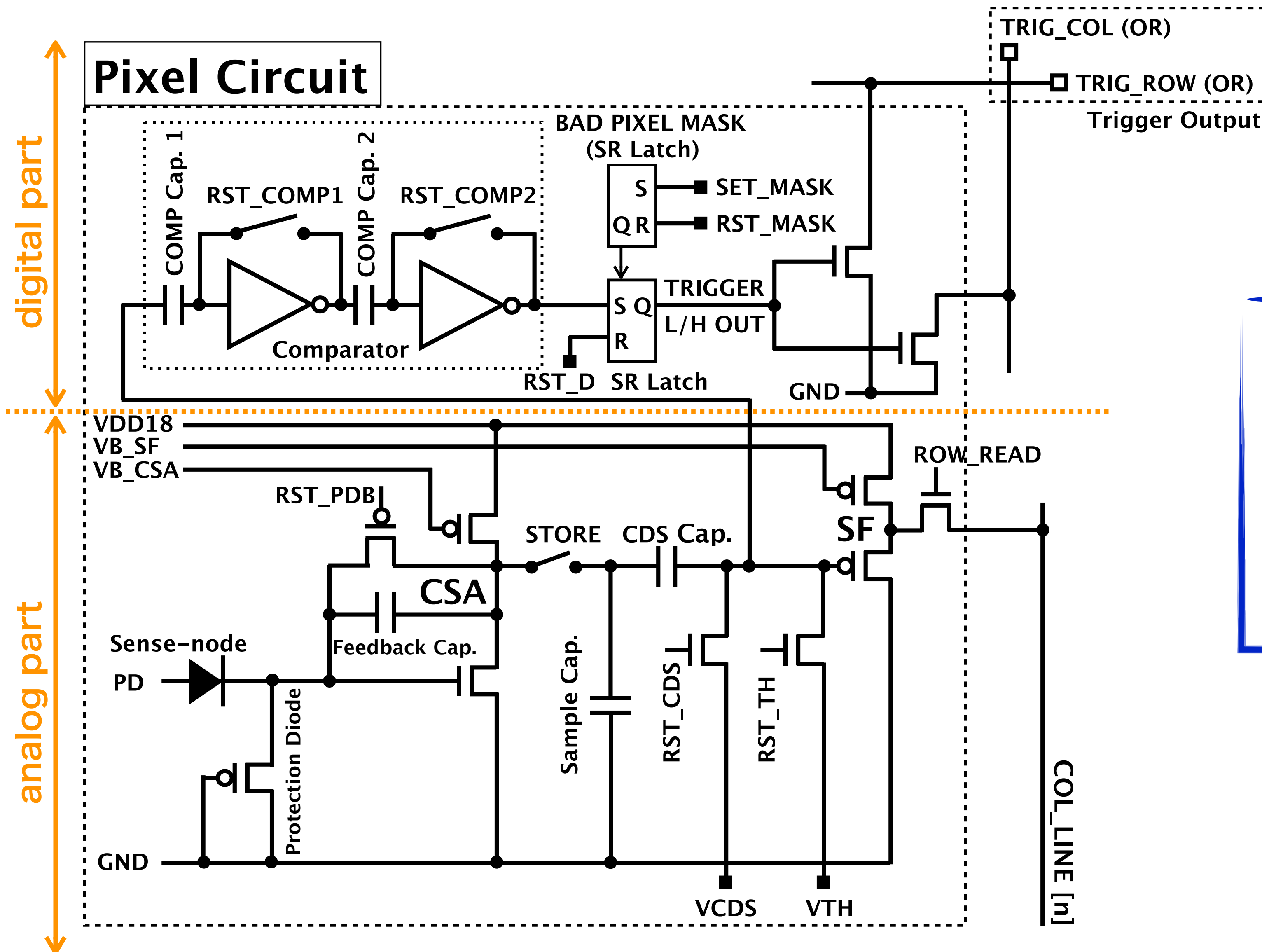
- Chip size : 4.45 mm x 4.45 mm
(Effective area : 1.7 mm x 1.7 mm)
- Pixel size : 36 μm sq.
- # of pixel : 48 x 48 (= ~2.3k)
- Thickness of sensor layer
-> 300 μm (CZ wafer / FZ wafer)

Other

- **Programmable Gain Amplifier (PGA)** circuit for column line.
- **Differential output** of signal and pedestal level.
- We considered more suitable architect constitution for event-driven readout.
-> 8 x 8 pixel readout per unit.

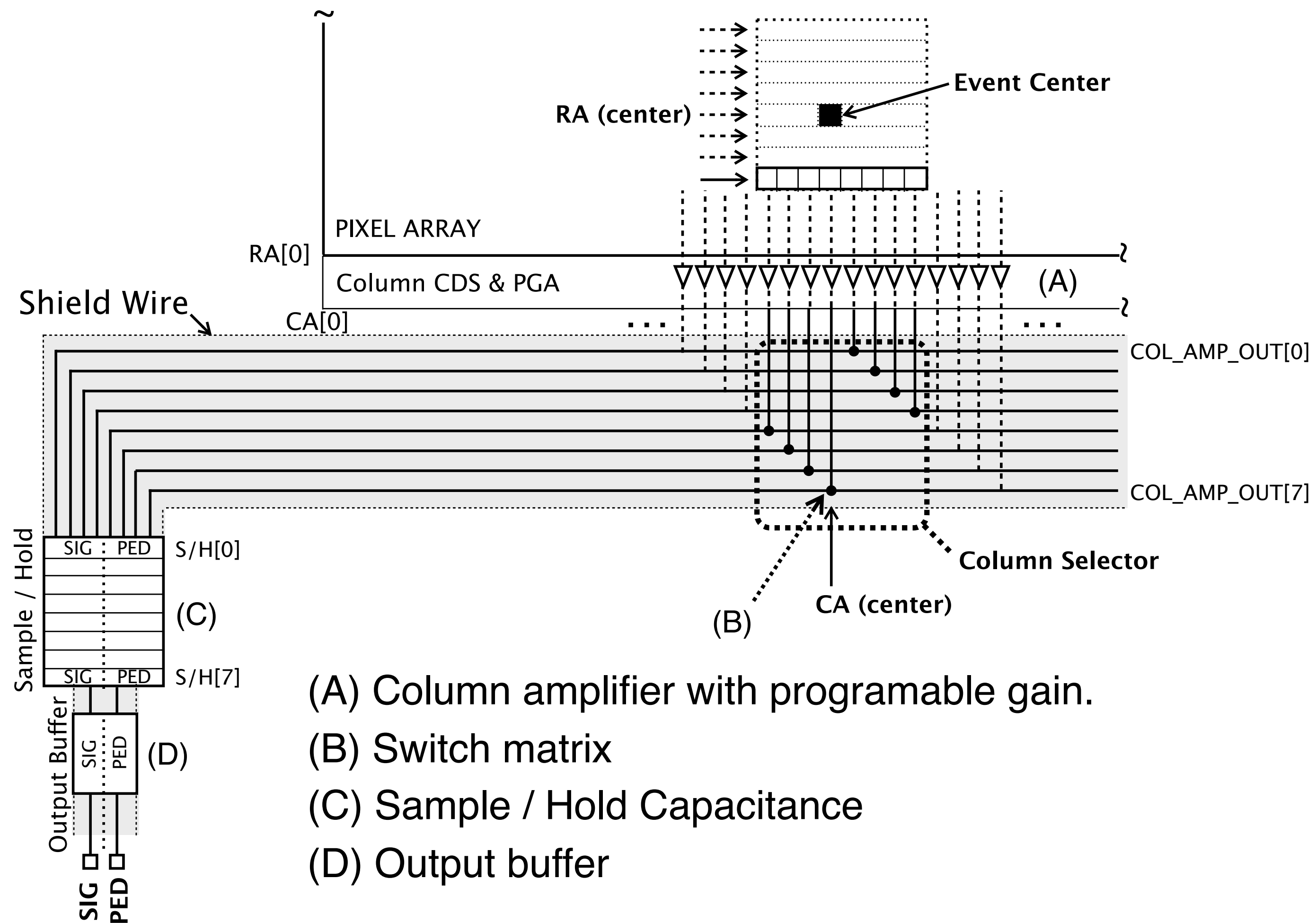


Pixel Circuit



- Pixel Circuit consists of ...**
- Charge-sensitive amplifier (CSA)
 - Correlated Double Sampling (CDS)
 - Inverter-chopper type comparator
 - SR Latch for bad pixel mask

Analog Readout Circuit

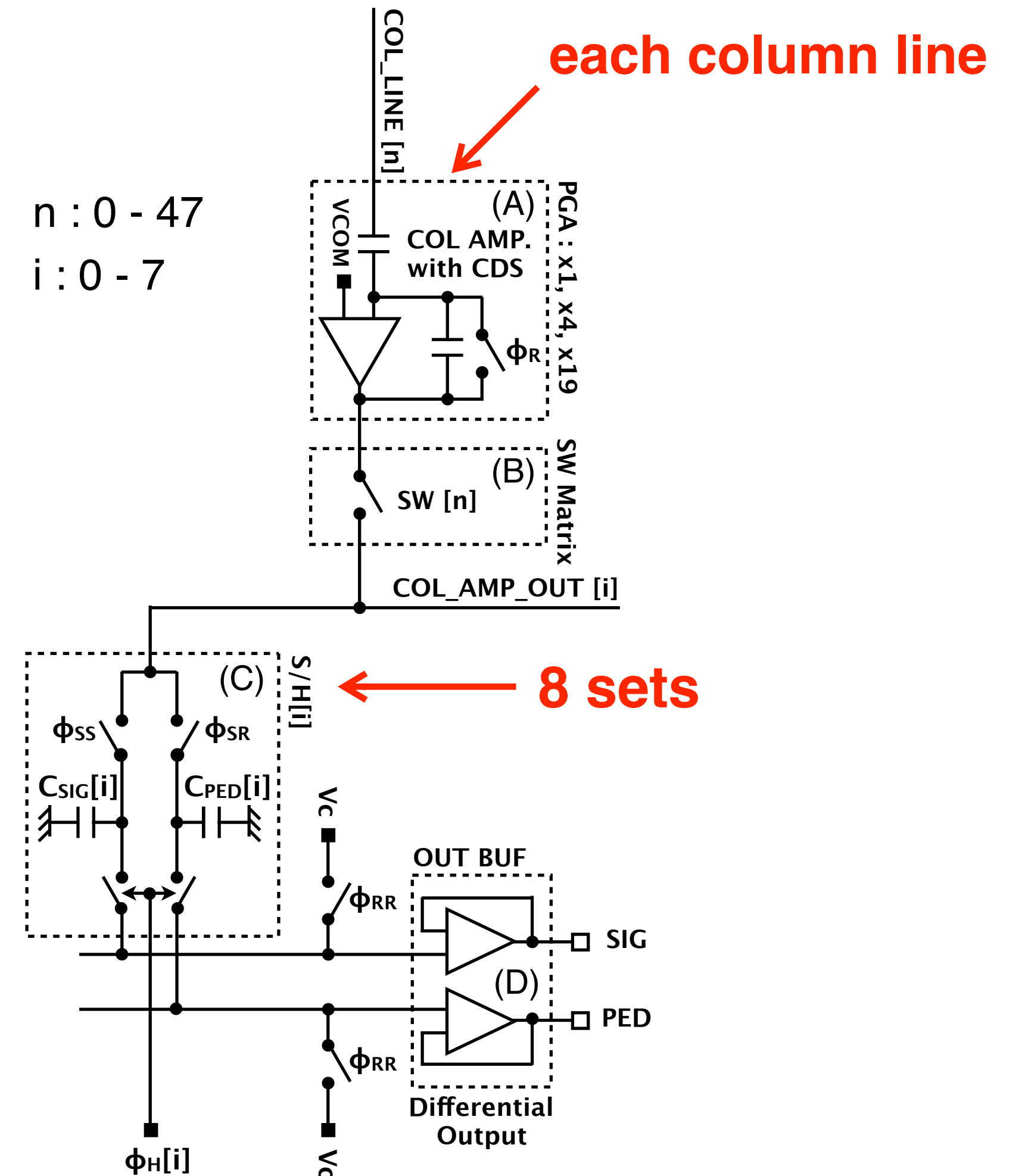


- (A) Column amplifier with programable gain.
- (B) Switch matrix
- (C) Sample / Hold Capacitance
- (D) Output buffer

Readout Pixel Unit : 8 x 8 pixels

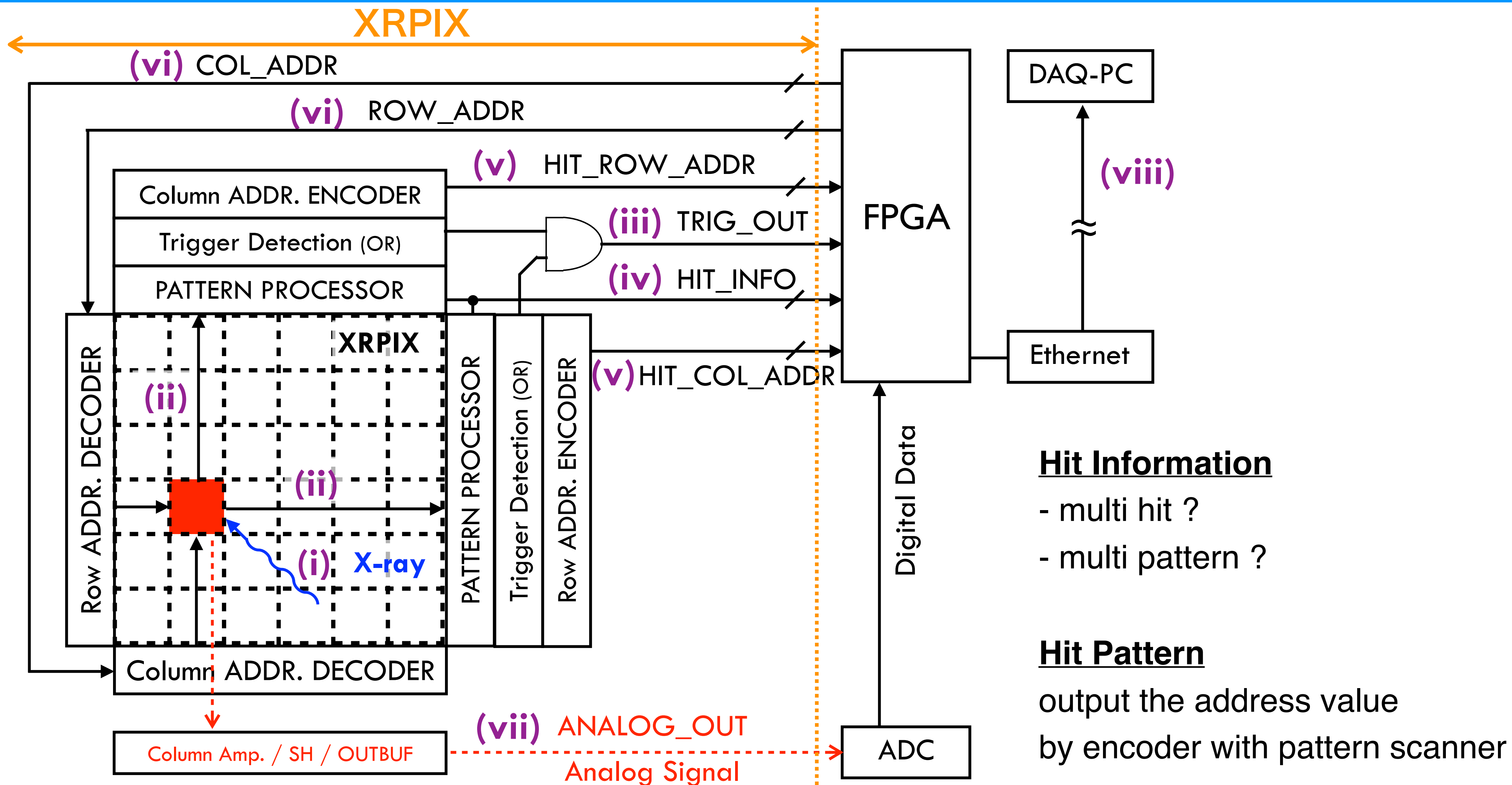
S/H Cap. : 8 sets

8 pixels scan/line x 8 lines



This configuration is more suitable for event-driven mode.

Event-driven Readout Mode



Hit Information

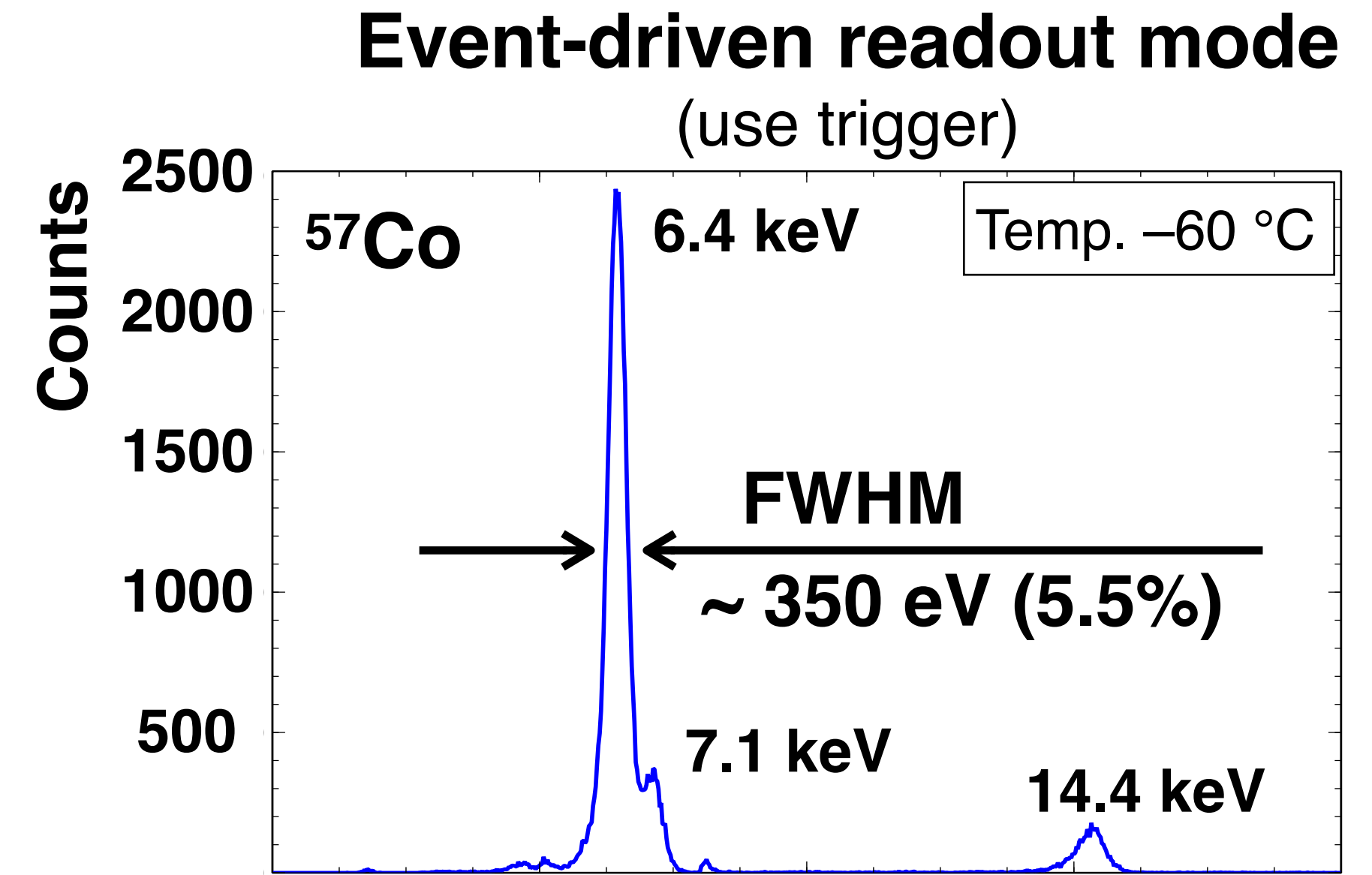
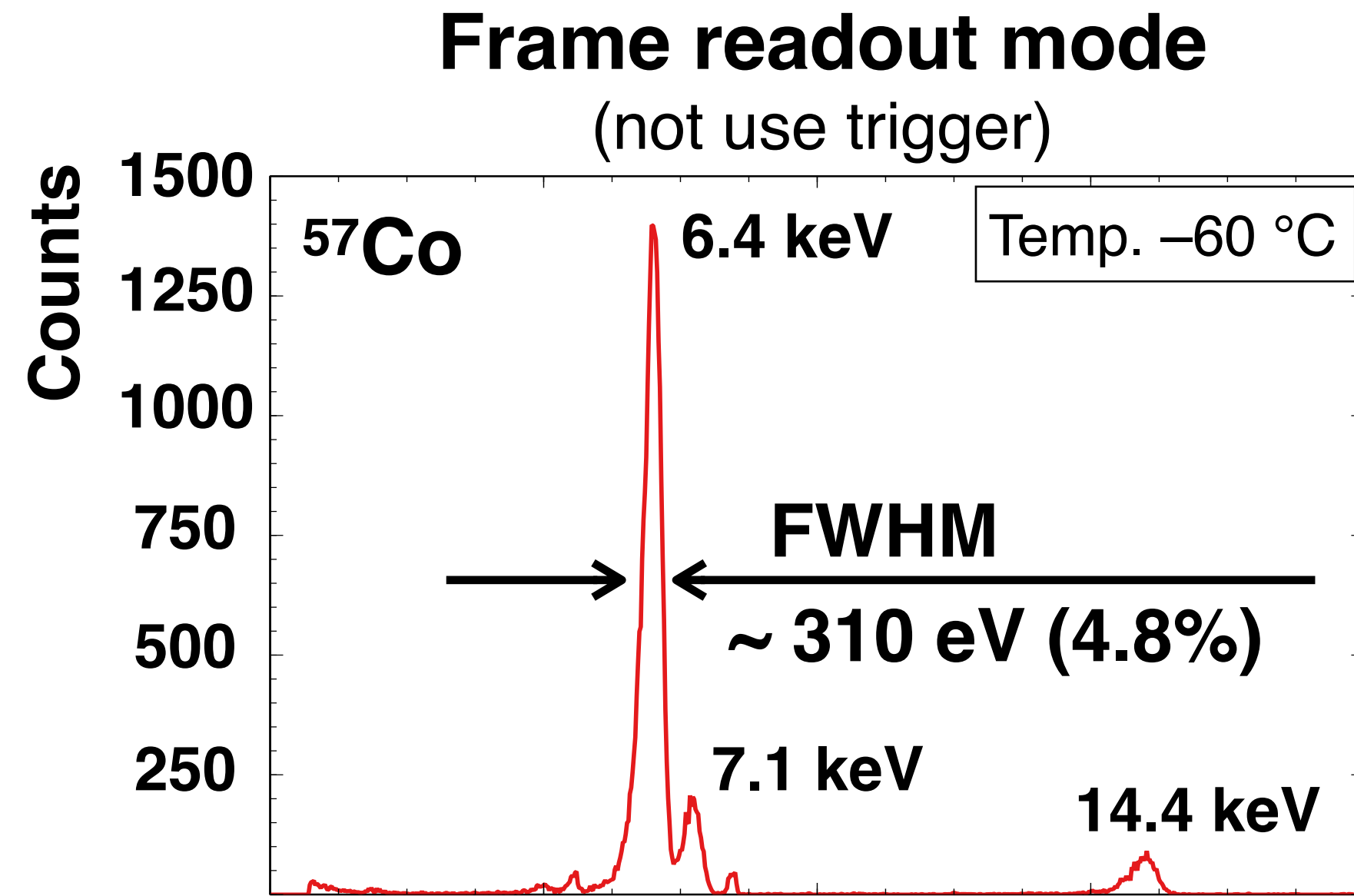
- multi hit ?
- multi pattern ?

Hit Pattern

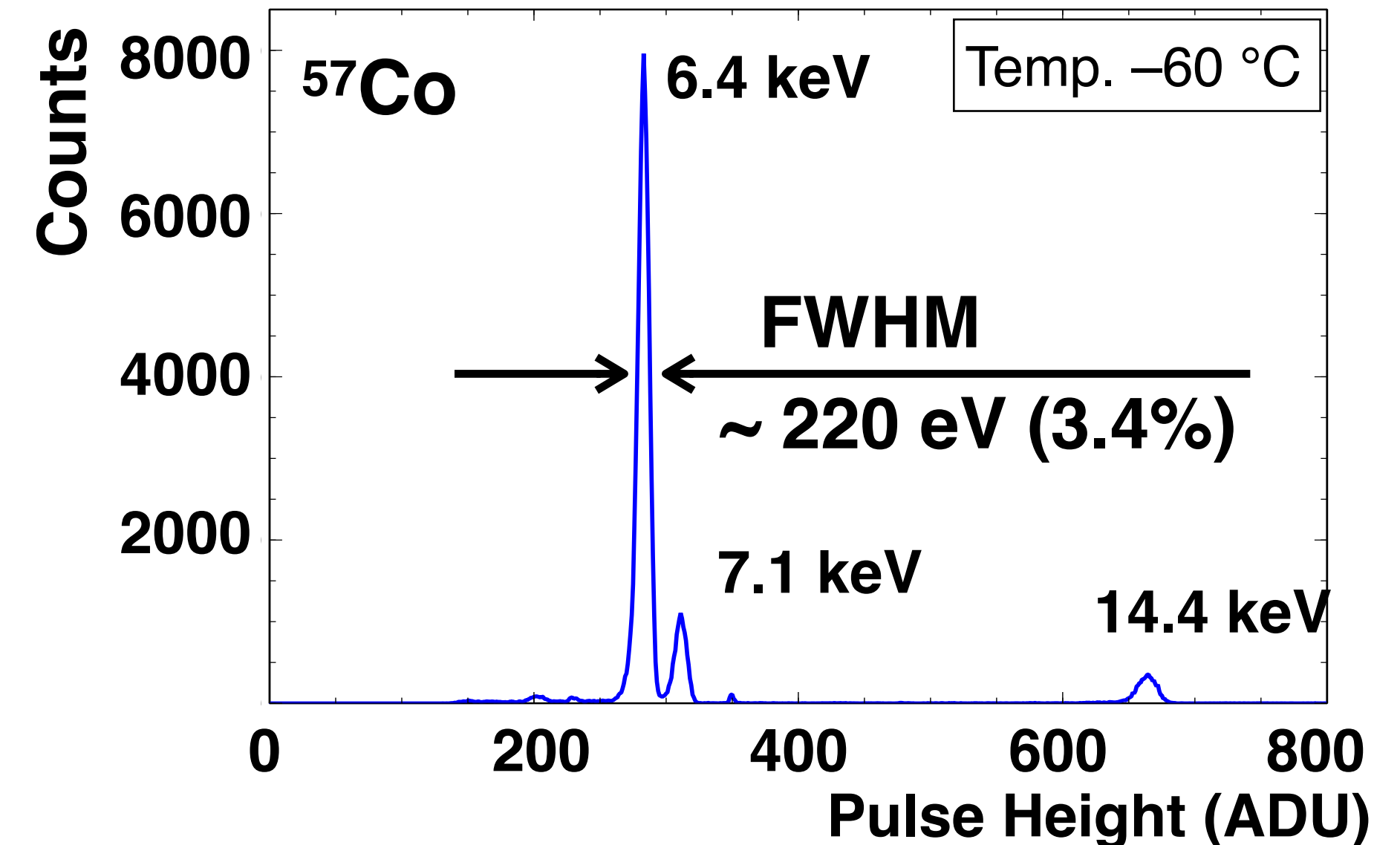
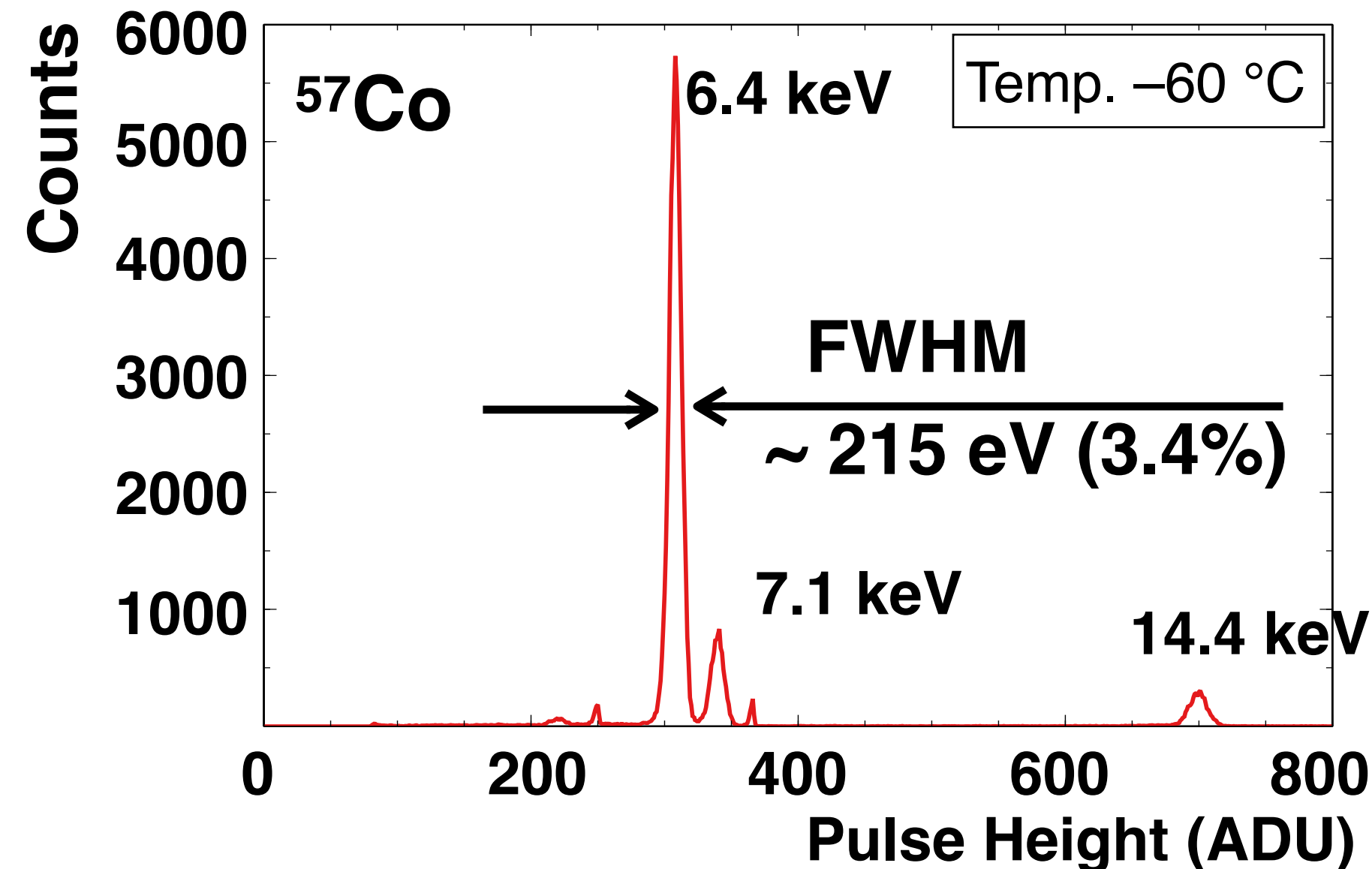
output the address value
by encoder with pattern scanner

Spectroscopic Performance

D-SOI



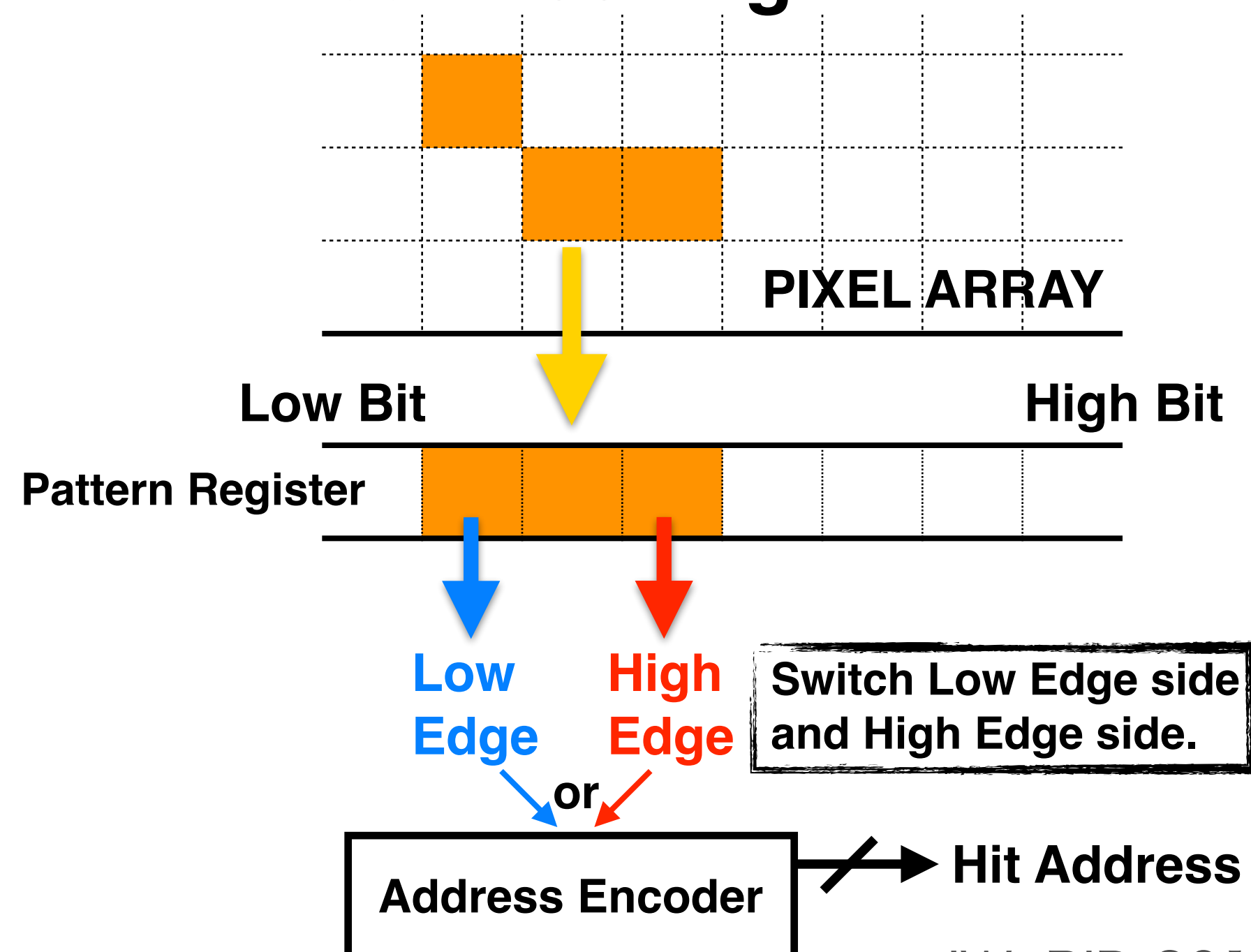
PDD



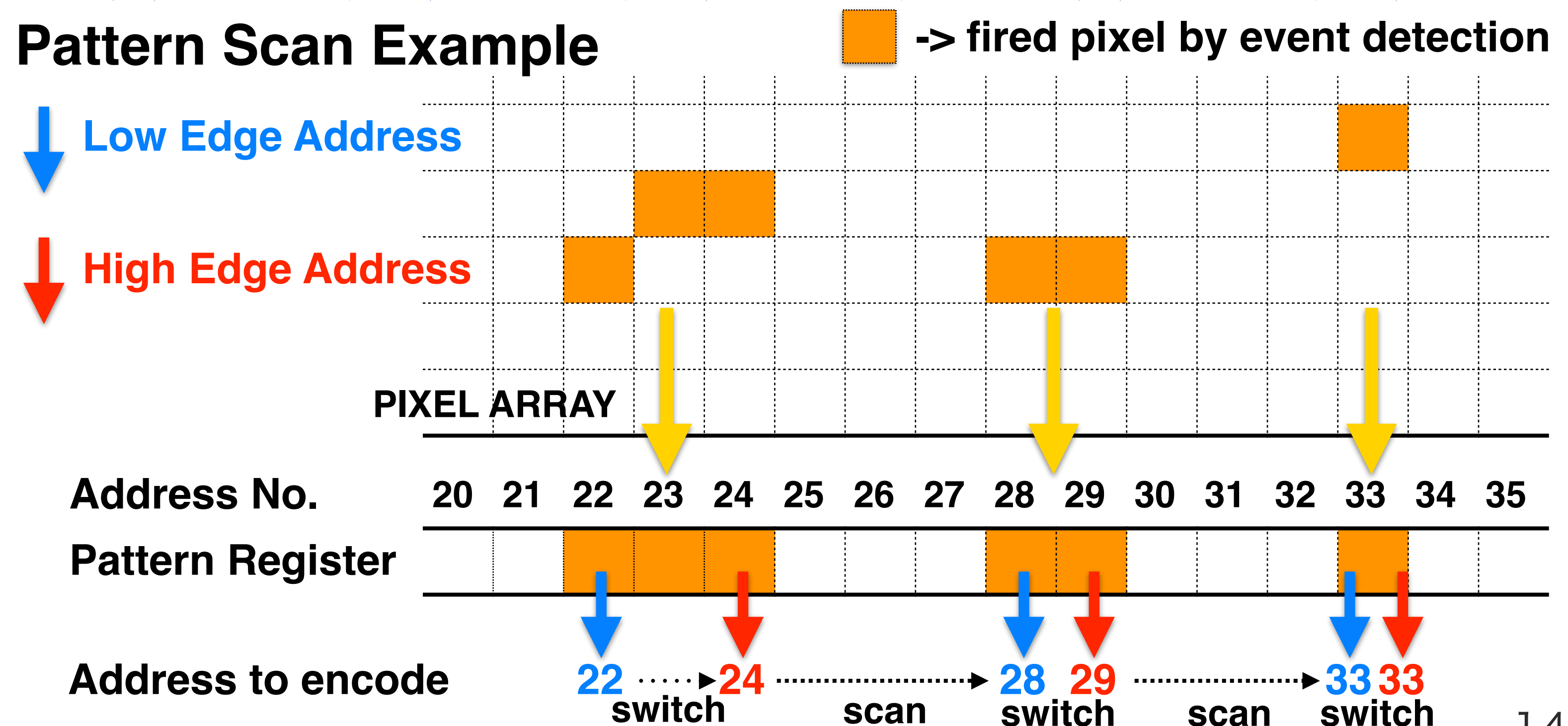
Peripheral Digital Circuit for Event-driven Readout

- XRPIX outputs the address of the place where the event is detected through the encoder circuit.
 - > Independent of Row Address (RA) side and Column Address (CA)
- By switching between “Low Edge” and “High Edge” addresses, we can know the position and size of events detected by only two address (Low / High) conversions.
- The output address is shifted by the input of the scan clock signal.
 - > Pattern scan function

Address Encoding



Pattern Scan Example



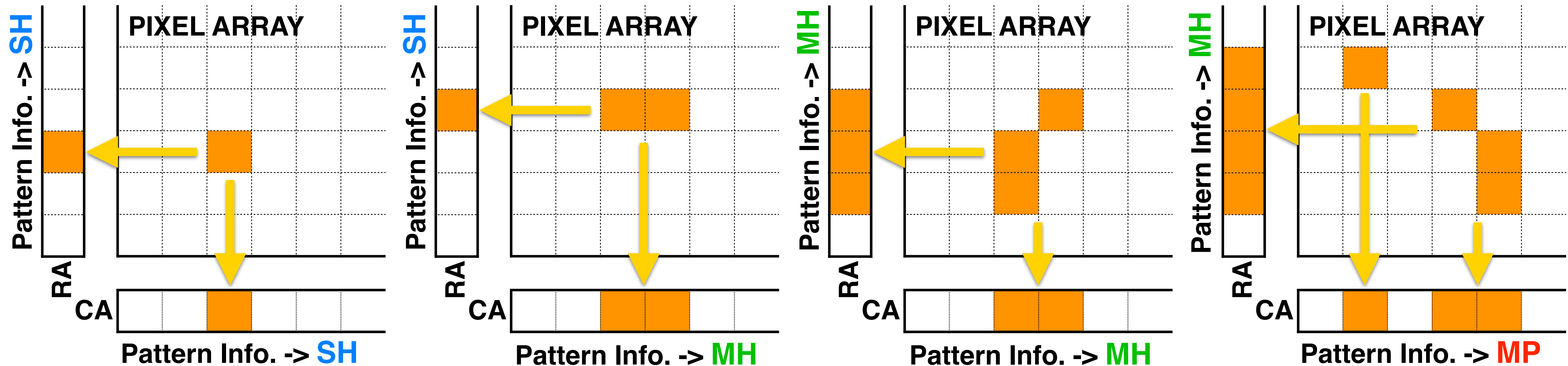
Peripheral Digital Circuit for Event-driven Readout

- XRPIX outputs pattern information processed by peripheral digital circuits in the chip.
 - > Independent of Row Address (RA) side and Column Address (CA) side
- Pattern information is classified as follows for each of RA side and CA side.

Single Hit (SH) : one pixel in all
Multi Hit (MH) : one continuous pattern
Multi Pattern (MP) : multiple continuous patterns

Pattern Examples

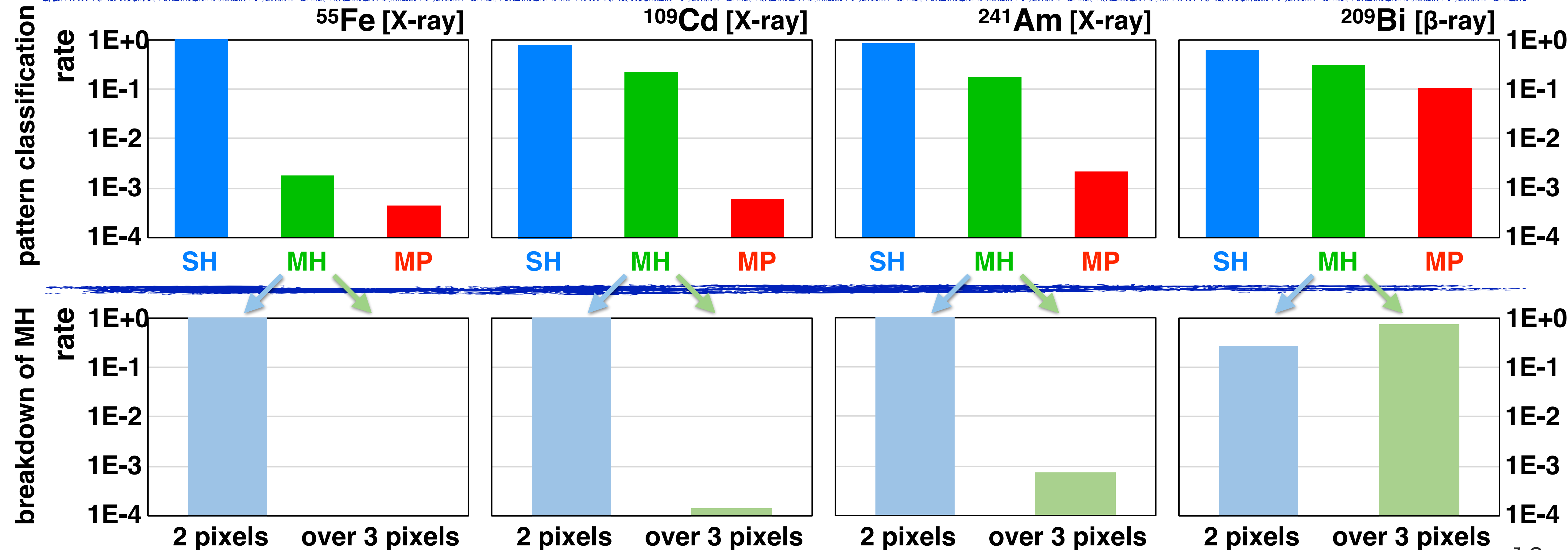
■ -> fired pixel by event detection



Test Results of Pattern Classification

- The difference in classification by radioactive source was tested using the pattern information of XRPIX6.
- > **front illumination** (affects the size of the charge cloud) / 100k events
- Under the condition that the firing pixel by event detection is two or less, we have the possibility of X-ray.

SH: one pixel in all
MH: one continuous pattern
MP: multiple continuous patterns



Summary

- We have been developing an event-driven SOIPIX sensor, “XRPIX”, for future X-ray astronomical satellite mission.
- We realize the event-driven readout mode and very low non-X-ray background by the function of the trigger signal output.
- We designed the new prototype, “XRPIX6D” and “XRPIX6E” with the Double-SOI structure and the PDD structure to improve spectroscopic performance.
 - > chip size: 4.45 mm x 4.45 mm, pixel size: 36 μm sq., number of pixel: 48 x 48 (= ~2.3k)
- We succeeded in improving the spectroscopic performance and suppressing the electrical crosstalk between sensing node and CMOS circuit by XRPIX6D and XRPIX6E.
 - > frame mode: 6D -> 310 eV (4.8%) @ 6.4 keV (FWHM), 6E -> 215 eV (3.4%) @ 6.4 keV (FWHM)
 - > event-driven mode: 6D -> 350 eV (5.5%) @ 6.4 keV (FWHM), 220 eV (3.4%) @ 6.4 keV (FWHM)
- Peripheral digital circuits for event-driven readout work good and can help with X-ray decisions.